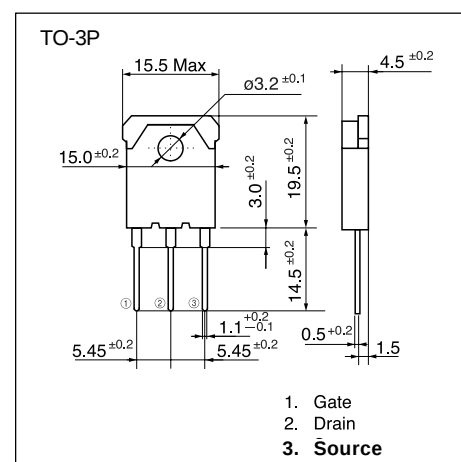


**N-CHANNEL SILICON POWER MOS-FET****■ Features**

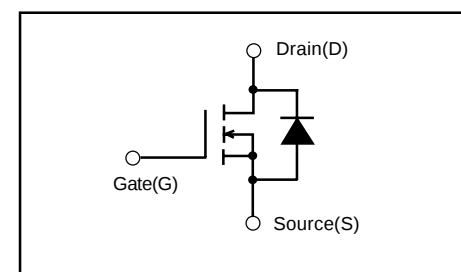
High speed switching  
 Low on-resistance  
 No secondary breakdown  
 Low driving power  
 Avalanche-proof

**■ Applications**

Switching regulators  
 UPS (Uninterruptible Power Supply)  
 DC-DC converters

**■ Maximum ratings and characteristic Absolute maximum ratings****● (T<sub>c</sub>=25°C unless otherwise specified)**

| Item                                    | Symbol                              | Rating              | Unit |
|-----------------------------------------|-------------------------------------|---------------------|------|
| Drain-source voltage                    | V <sub>DS</sub>                     | 60                  | V    |
| Continuous drain current                | I <sub>D</sub>                      | ±100                | A    |
| Pulsed drain current                    | I <sub>D</sub> (puls)               | ±400                | A    |
| Gate-source voltage                     | V <sub>GS</sub>                     | ±30                 | V    |
| Maximum Avalanche Energy                | E <sub>AV</sub> *1                  | 1268.3              | mJ   |
| Max. power dissipation                  | P <sub>D</sub>                      | 150                 | W    |
| Operating and storage temperature range | T <sub>ch</sub><br>T <sub>stg</sub> | +150<br>-55 to +150 | °C   |

\*1 L=0.169mH, V<sub>cc</sub>=24V**■ Equivalent circuit schematic****● Electrical characteristics (T<sub>c</sub> =25°C unless otherwise specified)**

| Item                             | Symbol              | Test Conditions                                                 | Min. | Typ. | Max. | Units |
|----------------------------------|---------------------|-----------------------------------------------------------------|------|------|------|-------|
| Drain-source breakdown voltage   | BV <sub>DSS</sub>   | I <sub>D</sub> =1mA V <sub>GS</sub> =0V                         | 60   |      |      | V     |
| Gate threshold voltage           | V <sub>GS(th)</sub> | I <sub>D</sub> =10mA V <sub>DS</sub> =V <sub>GS</sub>           | 2.5  | 3.0  | 3.5  | V     |
| Zero gate voltage drain current  | I <sub>DSS</sub>    | V <sub>DS</sub> =60V V <sub>GS</sub> =0V T <sub>ch</sub> =25°C  |      | 10   | 500  | μA    |
|                                  |                     | V <sub>DS</sub> =60V V <sub>GS</sub> =0V T <sub>ch</sub> =125°C |      | 0.2  | 1.0  | mA    |
| Gate-source leakage current      | I <sub>GSS</sub>    | V <sub>GS</sub> =±30V V <sub>DS</sub> =0V                       |      | 10   | 100  | nA    |
| Drain-source on-state resistance | R <sub>DS(on)</sub> | I <sub>D</sub> =50A V <sub>GS</sub> =10V                        |      | 5.7  | 7.8  | mΩ    |
| Forward transconductance         | g <sub>fs</sub>     | I <sub>D</sub> =50A V <sub>DS</sub> =25V                        | 25   | 55   |      | S     |
| Input capacitance                | C <sub>iss</sub>    | V <sub>DS</sub> =25V V <sub>GS</sub> =0V                        |      | 5400 | 8100 | pF    |
| Output capacitance               | C <sub>oss</sub>    | f=1MHz                                                          |      | 2100 | 3150 | pF    |
| Reverse transfer capacitance     | C <sub>rss</sub>    |                                                                 |      | 550  | 830  | pF    |
| Turn-on time t <sub>on</sub>     | td(on)              | V <sub>CC</sub> =30V I <sub>D</sub> =100A V <sub>GS</sub> =10V  |      | 29   | 50   | ns    |
|                                  | t <sub>r</sub>      |                                                                 |      | 200  | 350  | ns    |
| Turn-off time t <sub>off</sub>   | td(off)             | R <sub>GS</sub> =10 Ω                                           |      | 160  | 240  | ns    |
|                                  | t <sub>f</sub>      |                                                                 |      | 150  | 230  | ns    |
| Avalanche capability             | I <sub>AV</sub>     | L=100 μH T <sub>ch</sub> =25°C                                  | 100  |      |      | A     |
| Diode forward on-voltage         | V <sub>SD</sub>     | I <sub>F</sub> =100A V <sub>GS</sub> =0V T <sub>ch</sub> =25°C  |      | 1.0  | 1.5  | V     |
| Reverse recovery time            | t <sub>rr</sub>     | I <sub>F</sub> =50A V <sub>GS</sub> =0V                         |      | 85   |      | ns    |
| Reverse recovery charge          | Q <sub>rr</sub>     | -di/dt=100A/μs T <sub>ch</sub> =25°C                            |      | 0.21 |      | μC    |

**● Thermal characteristics**

| Item               | Symbol                | Test Conditions    | Min. | Typ. | Max. | Units |
|--------------------|-----------------------|--------------------|------|------|------|-------|
| Thermal resistance | R <sub>th(ch-c)</sub> | channel to case    |      |      | 0.83 | °C/W  |
|                    | R <sub>th(ch-a)</sub> | channel to ambient |      |      | 35.0 | °C/W  |

## Characteristics

